

L Number	Hits	Search Text		Time stamp
-	0	(chip or die) and (adhesive with (sodler adj mask))	PAT; -IGPUB; ; JPO; ENT; TDB	2002/09/20 13:24
-	88	(chip or die) and (adhesive with (solder adj mask))	NT; IGPUB; ; JPO; ENT; TDB	2002/09/20 13:57
-	58	((chip or die) and (adhesive with (solder adj mask))) and cur\$3	; ; GPUB; JPO; ENT; TDB	2002/09/20 13:32
-	4	257/783.CCLS. and (adhesive with (solder adj mask))	; ; GPUB; JPO; ENT; DB	2002/09/20 13:58
-	102	257/783.CCLS. and adhesive and ((solder adj mask) OR POLY\$5)	; ; GPUB; JPO; NT; DB	2002/09/20 14:01
-	1	257/783.CCLS. and (adhesive same ((solder adj mask) OR POLY\$5))	; ; GPUB; JPO; NT; DB	2002/09/20 14:04
-	10	257/783.CCLS. and (adhesive same (solder adj mask))	; ; GPUB; JPO; NT; DB	2002/09/20 14:09
-	20	257/783.CCLS. and (solder adj mask)	; ; GPUB; JPO; NT; DB	2002/09/20 14:15
-	8	257/782.ccls. and adhesive and (solder adj mask)	; ; GPUB; JPO; NT; DB	2002/09/20 14:17
-	292	(cur\$3 with adhesive) and (solder adj mask)	; ; GPUB; JPO; NT; DB	2002/09/20 14:19
-	201	((cur\$3 with adhesive) and (solder adj mask)) and (chip or die)	; ; GPUB; JPO; NT; DB	2002/09/20 14:19
-	187	((cur\$3 with adhesive) and (solder adj mask)) and (chip or die)) and (@ad<20010925)	; ; GPUB; JPO; NT; DB	2002/09/20 14:20